Supporting Information

Observation of Ambipolar Field-effect Behavior in Donor-Acceptor Conjugated Copolymers

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I. Atomic force microscopy (AFM) images

Figure S1 shows the tapping mode AFM topology images of PPcB and PCDTBT on PPcB. The AFM image obtained from PCDTBT deposited on an OTS-treated surface is presented for comparison.



Figure S1. AFM images of PPcB, PCDTBT on PPcB and PCDTBT on OTS.

II. Additional FET results

Figure S2 shows the FET results obtained from PTBT FET fabricated on an OTS-treated SiO₂ substrate. The transport and output characteristics are typical of p-type polymer FETs.



Figure S2. PTBT FET fabricated on OTS-treated SiO₂ substrate.

Figure S3 shows the output characteristic curves of PTBT FET fabricated on a PPcB passivation layer.



Figure S3. Output characteristics of a PTBT ambipolar FET fabricated on a PPcB layer.

Figure S4 shows the output characteristic curves of Si-PCPDTBT FET fabricated on a PPcB passivation layer.



Figure S4. Output characteristics of a Si-PCPDTBT ambipolar FET fabricated on a PPcB layer.